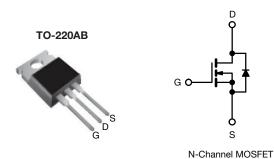
HALOGEN

FREE



E Series Power MOSFET



PRODUCT SUMMARY				
V_{DS} (V) at T_J max.	550			
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V	0.243		
Q _g max. (nC)	66			
Q _{gs} (nC)	8			
Q _{gd} (nC)	14			
Configuration	Single			

FEATURES

- Low figure-of-merit (FOM) Ron x Qq
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Low gate charge (Qq)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Computing
 - PC silver box / ATX power supplies
- Lighting
 - Two stage LED lighting
- · Consumer electronics
- · Applications using hard switched topologies
 - Power factor correction (PFC)
 - Two switch forward converter
 - Flyback converter
- Switch mode power supplies (SMPS)

ORDERING INFORMATION	
Package	TO-220AB
Load (Dh) free and halogen free	SiHP15N50E-BE3 ^a
Lead (Pb)-free and halogen-free	SiHP15N50E-GE3

Note

a. "-BE3" denotes alternate manufacturing location

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	500	V	
Gate-Source Voltage			V_{GS}	± 30	V	
Continuous Drain Current (T. – 150 °C)	T _C = 25 °C $T_{\rm C}$	-	14.5	А		
Continuous Drain Current (T _J = 150 °C)	V_{GS} at 10 V $T_{C} = 100 ^{\circ}$ C		l _D		9.2	
Pulsed Drain Current ^a			I _{DM}	28		
Linear Derating Factor				1.25	W/°C	
Single Pulse Avalanche Energy b			E _{AS}	136	mJ	
Maximum Power Dissipation			P_{D}	156	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	V _{DS} = 0 V to 80 % V _{DS}		dV/dt	70	V/ns	
Reverse Diode dV/dt d			uv/at	27	V/IIS	
Soldering Recommendations (Peak Temperature) c	for 10 s			300	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 3.1 A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$



Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W	
Maximum junction-to-case (drain)	R_{thJC}	-	0.8	G/ VV	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		^			•		
Drain-source breakdown voltage	V _{DS}	V _{GS} =	500	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, I _D = 1 mA		0.62	-	V/°C
Gate-source threshold Voltage (N)	V _{GS(th)}	V _{DS} =	V _{DS} = V _{GS} , I _D = 250 μA		-	4.0	V
		V _{GS} = ± 20 V		-	-	± 100	nA
Gate-source leakage	I _{GSS}	1	V _{GS} = ± 30 V		-	± 1	μΑ
Zana anto coltano durin accument		V _{DS} =	V _{DS} = 500 V, V _{GS} = 0 V		-	10	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 400 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	25	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 7.5 A	-	0.243	0.280	Ω
Forward transconductance	9 _{fs}	V _{DS} = 30 V, I _D = 7.5 A		-	3.9	-	S
Dynamic							
Input capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ f = 1 MHz		-	1162	-	pF
Output capacitance	C _{oss}			-	51	-	
Reverse transfer capacitance	C _{rss}			-	7	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V _{DS} = 0 V to 400 V, V _{GS} = 0 V		-	55	-	
Effective output capacitance, time related ^b	C _{o(tr)}			-	164	-	
Total gate charge	Qg			-	33	66	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_{D} = 7.5 \text{ A}, V_{DS} = 400 \text{ V}$		8	-	nC
Gate-drain charge	Q _{gd}			-	14	-	1
Turn-on delay time	t _{d(on)}	$V_{DD} = 400 \text{ V}, I_{D} = 12 \text{ A}, V_{GS} = 10 \text{ V}, R_{g} = 9.1 \Omega$		-	15	30	ns
Rise time	t _r			-	24	48	
Turn-off delay time	t _{d(off)}			-	34	68	
Fall time	t _f			-	18	36	
Gate input resistance	R_g	f = 1 MHz, open drain		-	0.85	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	14.5	
Pulsed diode forward current	I _{SM}			-	-	28	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 7.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	T _J = 25 °C, I _F = I _{S = 7.5 A} , dl/dt = 100 A/ μ s. V_R = 25 V		-	265	-	ns
Reverse recovery charge	Q _{rr}			-	3.2	-	μC
Reverse recovery current	I _{RRM}			_	23	-	A

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

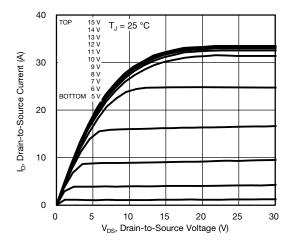


Fig. 1 - Typical Output Characteristics

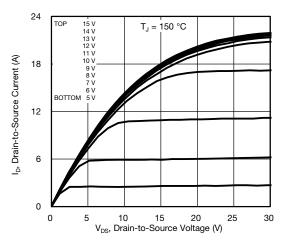


Fig. 2 - Typical Output Characteristics

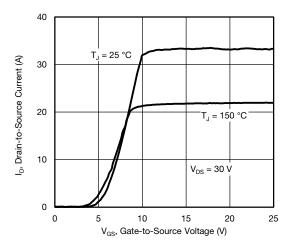


Fig. 3 - Typical Transfer Characteristics

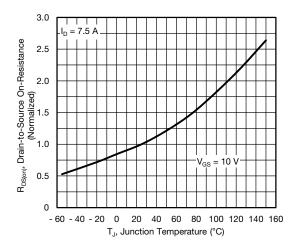


Fig. 4 - Normalized On-Resistance vs. Temperature

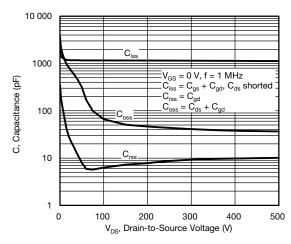


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

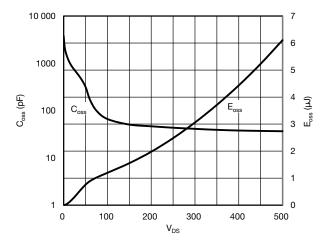


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



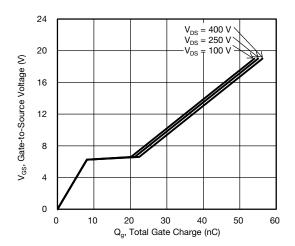


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

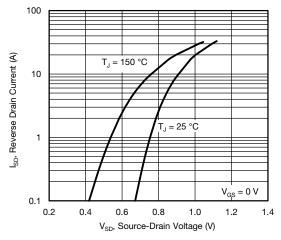


Fig. 8 - Typical Source-Drain Diode Forward Voltage

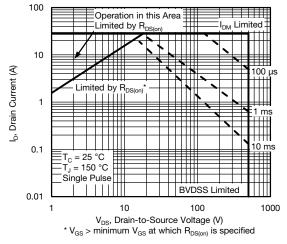


Fig. 9 - Maximum Safe Operating Area

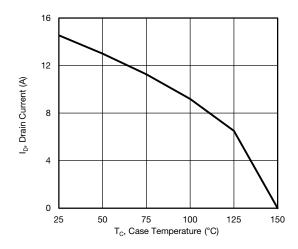


Fig. 10 - Maximum Drain Current vs. Case Temperature

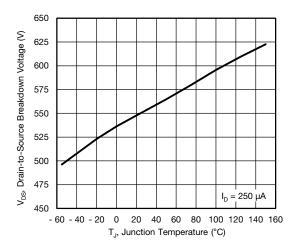


Fig. 11 - Temperature vs. Drain-to-Source Voltage



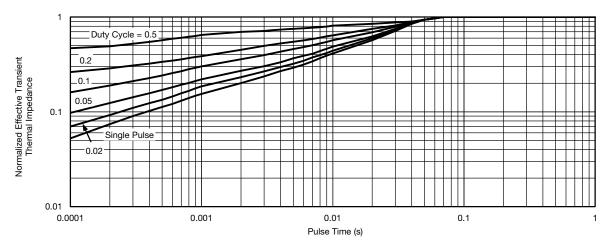


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

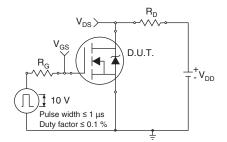


Fig. 13 - Switching Time Test Circuit

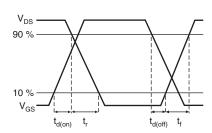


Fig. 14 - Switching Time Waveforms

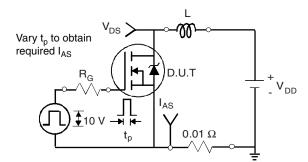


Fig. 15 - Unclamped Inductive Test Circuit

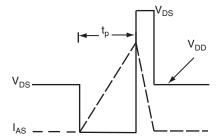


Fig. 16 - Unclamped Inductive Waveforms

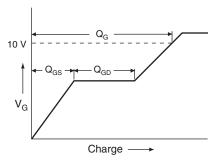


Fig. 17 - Basic Gate Charge Waveform

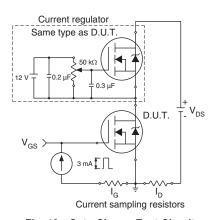
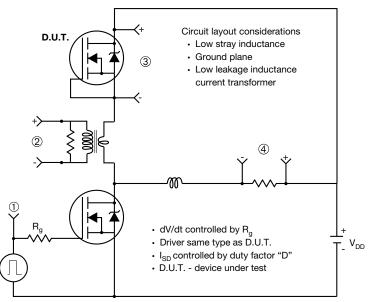


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



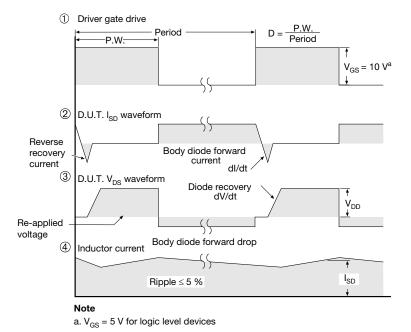


Fig. 19 - For N-Channel

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